Multi-Phase PWM Controller for K8 CPU Core Power Supply

General Description

RT9245B is a multi-phase buck DC/DC controller integrated with all control functions for AMD K8 CPU. The RT9245B could be operated with 2, 3 or 4 buck switching stages operating in interleaved phase set automatically. The multiphase architecture provides high output current while maintaining low power dissipation on power devices and low stress on input and output capacitors. The high equivalent operating frequency also reduces the component dimension and the output voltage ripple in load transient.

RT9245B implements both voltage and current loops to achieve good regulation, response and power stage thermal balance.

RT9245B applies the DCR sensing technology newly. The RT9245B extracts the ESR of output inductor as sense component to deliver a precise load line regulation and good thermal balance for next generation processor application.

Current sense setting, droop tuning, V_{CORE} initial offset and over current protection are independent on compensation circuit of voltage loop. The feature greatly facilitates the flexibility of CPU power supply design and tuning. The DAC output of RT9245B supports AMD K8 6-bit VID, precise offset value & smooth V_{CORE} transient at V_{ID} jump. The IC monitors the V_{CORE} voltage for PGOOD and over-voltage protection. Soft-start, over-current protection and programmable under-voltage lockout are also provided to assure the safety of microprocessor and power system. The RT9245B comes to a small footprint package TSSOP-28.

Ordering Information



- Package Type
- C : TSSOP-28
- -Operating Temperature Range
- P : Pb Free with Commercial Standard G : Green (Halogen Free with Commer
 - cial Standard)

Features

- Multi-Phase Power Conversion with Automatic Phase Selection
- 6-bit AMD K8 M2 DAC Output with Active Droop Compensation for Fast Load Transient
- Smooth V_{CORE} Transition at VID Jump
- Power Stage Thermal Balance by DCR Current Sense
- Hiccup Mode Over-Current Protection
- Programmable Switching Frequency (50kHz to 400kHz per Phase), Under-Voltage Lockout and Soft-Start
- High Ripple Frequency Times Channel Number
- 1 28-TSSOP Package
- RoHS Compliant and 100% Lead (Pb)-Free

Applications

- 1 AMD K8 Processors Voltage Regulator
- Low Output Voltage, High Current DC-DC Converters
- Voltage Regulator Modules

Pin Configurations

(TOP VIEW)						
VID4 C	• 2	28 27				
	3 4	26 25	PWM2			
	5	24	PWM4			
	6 7	23 22	CSP4			
FB 🗔	8	21	CSP3			
	9 10	20 19	CSP1			
	11	18	ADJ			
SS 🗔 RT 🗔	12 13	17 16				
voss 🖂	14	15				

TSSOP-28

Note :

RichTek Pb-free and Green products are :

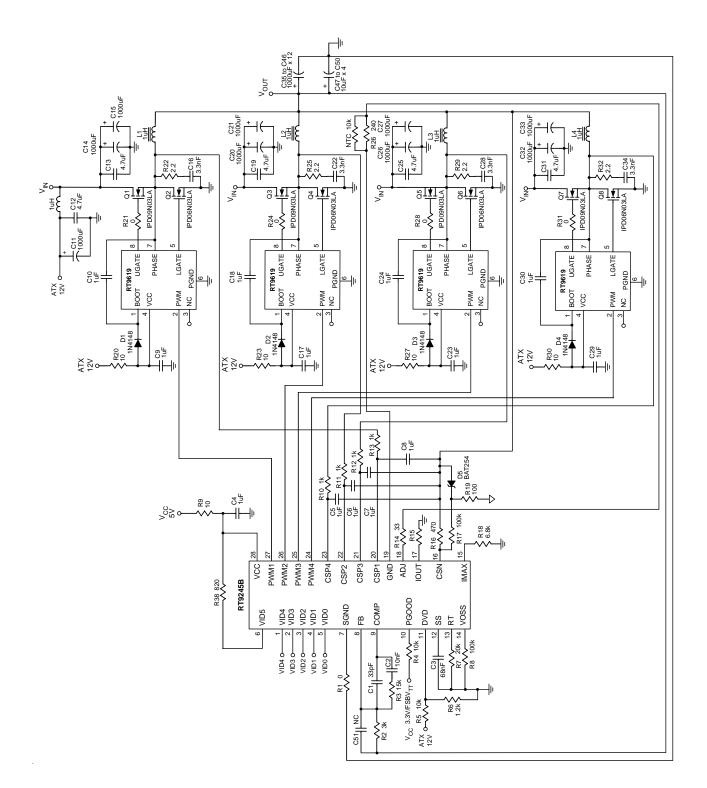
- }RoHS compliant and compatible with the current requirements of IPC/JEDEC J-STD-020.
- }Suitable for use in SnPb or Pb-free soldering processes.
 }100% matte tin (Sn) plating.

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Typical Application Circuit



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Functional Pin Description

VID4 (Pin 1), VID3 (Pin 2), VID2 (Pin 3), VID1 (Pin 4), VID0 (Pin 5), VID5 (Pin 6)

DAC voltage identification inputs for K8. These pins are internally pulled to 1.2V if left open.

SGND (Pin 7)

 V_{CORE} differential sense negative input.

FB (Pin 8)

Inverting input of the internal error amplifier.

COMP (Pin 9)

Output of the error amplifier and input of the PWM comparator.

PGOOD (Pin 10)

Power good open-drain output.

DVD (Pin 11)

Programmable power UVLO detection input. Trip threshold = 1.0V at V_{DVD} rising.

SS (Pin 12)

Connect this SS pin to GND with a capacitor to set the soft-start time interval.

RT (Pin 13)

Switching frequency setting. Connect this pin to GND with a resistor to set the frequency.

VOSS (Pin 14)

 V_{CORE} initial value offset. Connect this pin to GND with a resistor to set the negative offset value. Connect this pin to VCC to set positive offset value.

IMAX (Pin 15)

Programmable over currert setting.

CSN (Pin 16)

Current sense negative input of all channels.

IOUT (Pin 17)

Output Current Indication Pin. The current through IOUT pin is proportional to the output current.

ADJ (Pin 18)

Current sense output for active droop adjust. Connect a resistor from this pin to GND to set the load droop.

GND (Pin 19)

Ground for the IC.

CSP1 (Pin 20), CSP2 (Pin 22), CSP3 (Pin 21) & CSP4 (Pin 23)

Current sense positive inputs for individual converter channel current sense.

PWM1 (Pin 27), PWM2 (Pin 26), PWM3 (Pin 25) & PWM4 (Pin 24)

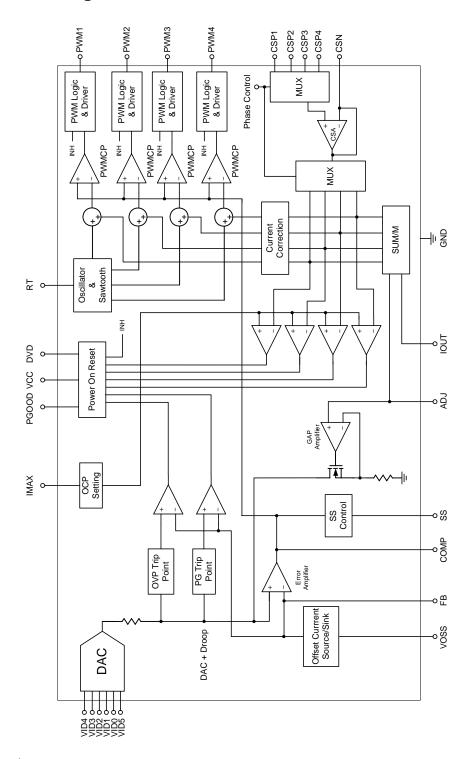
PWM outputs for each driven channel. Connect these pins to the PWM input of the MOSFET driver. For systems which use 3 channels, connect PWM4 high. Two channel systems connect PWM3 high.

VCC (Pin 28)

IC power supply. Connect this pin to a 5V supply.



Function Block Diagram



	Pin Name					
VID5	VID4	VID3	VID2	VID1	VID0	Nominal Output Voltage DACOUT
0	0	0	0	0	0	1.5500
0	0	0	0	0	1	1.5250
0	0	0	0	1	0	1.5000
0	0	0	0	1	1	1.4750
0	0	0	1	0	0	1.4500
0	0	0	1	0	1	1.4250
0	0	0	1	1	0	1.4000
0	0	0	1	1	1	1.3750
0	0	1	0	0	0	1.3500
0	0	1	0	0	1	1.3250
0	0	1	0	1	0	1.3000
0	0	1	0	1	1	1.2750
0	0	1	1	0	0	1.2500
0	0	1	1	0	1	1.2250
0	0	1	1	1	0	1.2000
0	0	1	1	1	1	1.1750
0	1	0	0	0	0	1.1500
0	1	0	0	0	1	1.1250
0	1	0	0	1	0	1.1000
0	1	0	0	1	1	1.0750
0	1	0	1	0	0	1.0500
0	1	0	1	0	1	1.0250
0	1	0	1	1	0	1.0000
0	1	0	1	1	1	0.9750
0	1	1	0	0	0	0.9500
0	1	1	0	0	1	0.9250
0	1	1	0	1	0	0.9000
0	1	1	0	1	1	0.8750
0	1	1	1	0	0	0.8500
0	1	1	1	0	1	0.8250
0	1	1	1	1	0	0.8000
0	1	1	1	1	1	0.7750
1	0	0	0	0	0	0.7625
1	0	0	0	0	1	0.7500

Table 1. Output Voltage Program

To be continued

	Pin Name					
VID5	VID4	VID3	VID2	VID1	VID0	Nominal Output Voltage DACOUT
1	0	0	0	1	0	0.7375
1	0	0	0	1	1	0.7250
1	0	0	1	0	0	0.7125
1	0	0	1	0	1	0.7000
1	0	0	1	1	0	0.6875
1	0	0	1	1	1	0.6750
1	0	1	0	0	0	0.6625
1	0	1	0	0	1	0.6500
1	0	1	0	1	0	0.6375
1	0	1	0	1	1	0.6250
1	0	1	1	0	0	0.6125
1	0	1	1	0	1	0.6000
1	0	1	1	1	0	0.5875
1	0	1	1	1	1	0.5750
1	1	0	0	0	0	0.5625
1	1	0	0	0	1	0.5500
1	1	0	0	1	0	0.5375
1	1	0	0	1	1	0.5250
1	1	0	1	0	0	0.5125
1	1	0	1	0	1	0.5000
1	1	0	1	1	0	0.4875
1	1	0	1	1	1	0.4750
1	1	1	0	0	0	0.4625
1	1	1	0	0	1	0.4500
1	1	1	0	1	0	0.4375
1	1	1	0	1	1	0.4250
1	1	1	1	0	0	0.4125
1	1	1	1	0	1	0.4000
1	1	1	1	1	0	0.3875
1	1	1	1	1	1	0.3750

Table 1. Output Voltage Program

Note: (1) 0 : Connected to GND

(2) 1 : Open

Absolute Maximum Ratings (Note 1)

ı	Supply Voltage, Vcc	7V
ı	Input, Output or I/O Voltage	$GND-0.3V$ to V_{CC} + 0.3V
ı	Power Dissipation, $P_D @ T_A = 25^{\circ}C$	
	TSSOP-28	1W
Т	Package Thermal Resistance (Note 4)	
	TSSOP-28, θ _{JA}	100°C/W
Т	Junction Temperature	150°C
Т	Lead Temperature (Soldering, 10 sec.)	260°C
Т	Storage Temperature Range	–65°C to 150°C
I	ESD Susceptibility (Note 2)	
	HBM (Human Body Mode)	2kV
	MM (Machine Mode)	200V

Recommended Operating Conditions (Note 3)

ı	Supply Voltage, V _{CC}	$5V \pm 10\%$
I	Junction Temperature Range	$-40^\circ C$ to $125^\circ C$
ı	Ambient Temperature Range	$-40^{\circ}C$ to $85^{\circ}C$

Electrical Characteristics

(V_{CC} = 5V, T_A = 25°C, unless otherwise specified)

Parameter		Symbol	Test Conditions	Min	Тур	Max	Units
V _{CC} Supply Curi	rent						
Nominal Supply C	Current	I _{CC}	PWM 1,2,3,4 Open		12	16	mA
Power-On Reset							
POR Threshold		V _{CCRTH}	V _{CC} Rising	4.0	4.2	4.5	V
Hysteresis		V _{CCHYS}		0.2	0.5		V
	Trip (Low to High)	Vdvdtp	Enable	0.94	1.0	1.06	V
V _{DVD} Threshold	Hysteresis	V _{DVDHYS}			50		mV
Oscillator							
Free Running Frequency		fosc	$R_{RT} = 20k\Omega$	170	200	230	kHz
Frequency Adjust	able Range	fosc adj		50		400	kHz
Ramp Amplitude		ΔV_{OSC}	$R_{RT} = 20k\Omega$		1.9		V
Ramp Valley		V _{RV}		0.7	1.0		V
Maximum Duty of Each Channel				58	64	70	%
RT Pin Voltage		V _{RT}	$R_{RT} = 20k\Omega$	0.9	1.0	1.1	V
Reference and D	AC						
	Accuracy	ΔV _{DAC}	$V_{DAC} \ge 1V$	-1		+1	%
DACOUT Voltage Accuracy		△ V DAC	V _{DAC} < 1V	-10		+10	mV
DAC (VID0-VID5) Input Low		VILDAC				0.8	V
DAC (VID0-VID5)	Input High	VIHDAC		1.2			V

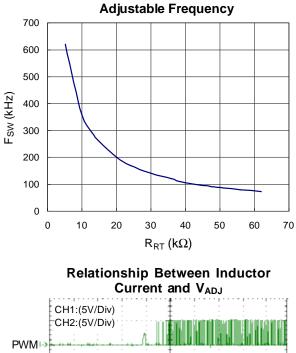
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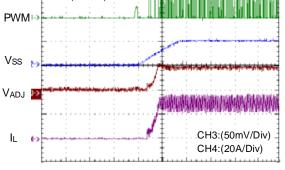
Parameter	Symbol	Test Conditions	Min	Тур	Max	Units
DAC (VID0-VID5) pull up resistor			2.5	3.5	4.5	kΩ
DAC Pull Up Voltage				2.1		V
VOSS Pin Voltage	V _{VOSS}	$R_{VOSS} = 100 k\Omega$	0.9	1.0	1.1	V
Error Amplifier						
DC Gain				60		dB
Gain-Bandwidth Product	GBW			10		MHz
Slew Rate	SR	COMP = 10pF		6		V/µs
Current Sense GM Amplifier	-	•				
CSN Full Scale Source Current	IISPFSS		100			μΑ
CSN Current for OCP			150			μΑ
Protection						
Over-Voltage Trip (V _{FB} – V _{DAC})	Δ_{OVT}	$R_{ADJ} = 0\Omega$	320	400	450	mV
IMAX Voltage	VIMAX	$R_{IMAX} = 20k\Omega$	0.9	1.0	1.1	V
Power Good	-			•	-	-
Output Low Voltage	V _{PGOODL}	I _{PGOOD} = 4mA			0.2	V

Note 1. Stresses listed as the above "Absolute Maximum Ratings" may cause permanent damage to the device. These are for stress ratings. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may remain possibility to affect device reliability.

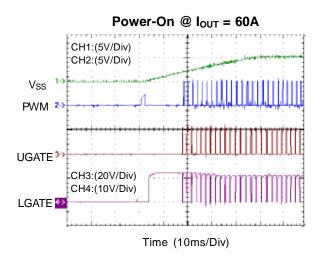
- Note 2. Devices are ESD sensitive. Handling precaution recommended.
- Note 3. The device is not guaranteed to function outside its operating conditions.
- Note 4. θ_{JA} is measured in the natural convection at $T_A = 25^{\circ}C$ on a low effective single layer thermal conductivity test board of JEDEC 51-3 thermal measurement standard.

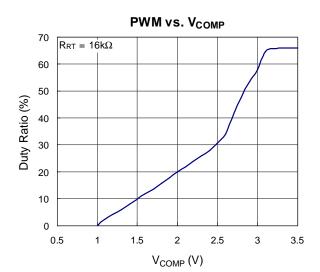


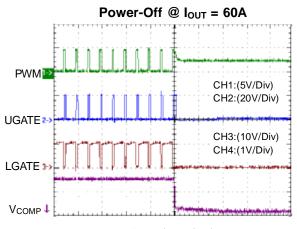




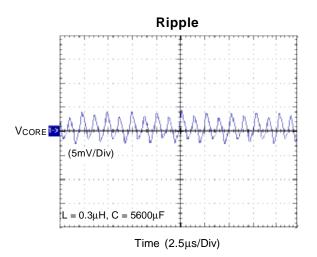
Time (25ms/Div)



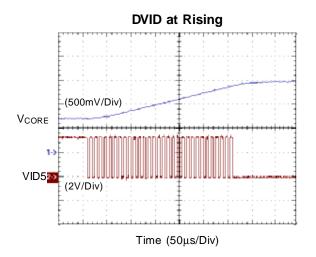


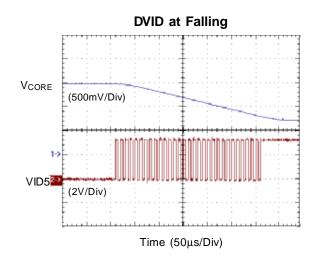


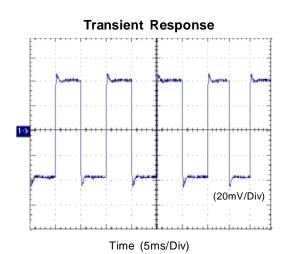
Time (10µs/Div)

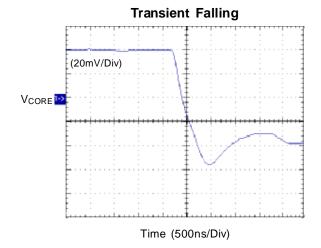












Application Information

RT9245B is a multi-phase DC/DC controller that precisely regulates CPU core voltage and balances the current of different power channels. The converter consisting of RT9245B and its companion MOSFET driver RT9619 provides high quality CPUpower and all protection functions to meet the requirement of modern VRM.

Voltage Control

RT9245B senses the CPU V_{CORE} by SGND pin to sense the return of CPU to minimize the voltage drop on PCB trace at heavy load. OVP is sensed at FB pin. The internal high accuracy VIDDAC provides the reference voltage for K8 compliance. Control loop consists of error amplifier, multi-phase pulse width modulator, driver and power components. As conventional voltage mode PWM controller, the output voltage is locked at the VREF of error amplifier and the error signal is used as the control signal of pulse width modulator. The PWM signals of different channels are generated by comparison of EA output and split-phase sawtooth wave. Power stage transforms VIN to output by PWM signal on-time ratio.

Current Balance

RT9245B senses the inductor current via inductor's DCR for channel current balance and droop tuning. The differential sensing GM amplifier converts the voltage on the sense component (can be a sense resistor or the DCR of the inductor) to current signal into internal balance circuit.

The current balance circuit sums and averages the current signals and then produces the balancing signals injected to pulse width modulator. If the current of some power channel is larger than average, the balancing signal reduces that channels pulse width to keep current balance. The use of single GM amplifier via time sharing technique to sense all inductor currents can reduce the offset errors and linearity variation between GMs. Thus it can greatly improve signal processing especially when dealing with such small signal as voltage drop across DCR.

Droop & Load Line Setting

RT9245B injects averaged current $\overline{I_X}$ into the resistor R_{ADJ} connected to ADJ pin to generate a load-currentdependent voltage R_{ADJ} for droop setting: $VADJ = 8 \times I \times RADJ$

 V_{ADJ} is then subtracted from VID_DAC output as the real reference voltage at non-inverting input of the error amplifier as shown if Figure 1. Consequently, load line slope is calculated as :

 $Load Line = \frac{\Delta V_{CORE}}{\Delta I_{CORE}} = \frac{8 \text{ x Radj x DCR}}{N \text{ x Rcsn}}$

where N is the phase number of operation.

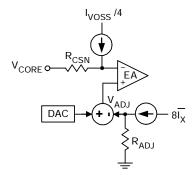


Figure 1. Load Line and Offset Function

Fault Detection

The chip detects FB for over voltage and power good detection. The "hiccup mode" operation of over current protection is adopted to reduce the short circuit current. The in-rush current at the start up is suppressed by the soft start circuit through clamping the pulse width and output voltage.

Phase Setting and Converter Start Up

RT9245B interfaces with companion MOSFET drivers (like RT9619, RT9607 series) for correct converter initialization. The tri-state PWM output (high, low and high impedance) senses its interface voltage when IC POR acts (both VCC and DVD trip). The channel is enabled if the pin voltage is 1.2V less than VCC. Tie the PWM to VCC and the corresponding current sense pins to GND or left float if the channel is unused. For example, for 3-Channel application, connect PWM4 high.

Current Sensing Setting

RT9245B senses the current flowing through inductor via its DCR for channel current balance and droop tuning.

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The differential sensing GM amplifier converts the voltage on the sense component (can be a sense resistor or the DCR of the inductor) to current signal into internal circuit (see Figure 2).

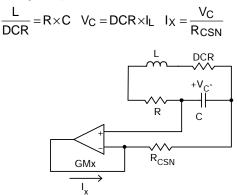
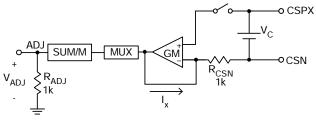
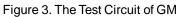
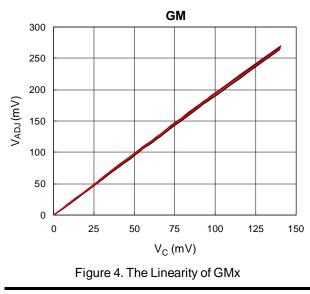


Figure 2. Current Sense Circuit

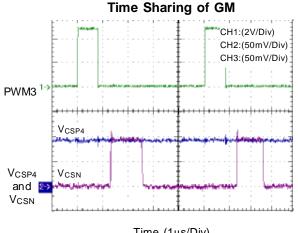
Figure 3 is the test circuit for GM. We apply test signal at GM inputs and observe its signal process output at ADJ pin. Figure 4 shows the variation of signal processing of all channels. We observe zero offsets and good linearity between phases.







www.richtek.com 12 Figure 5 shows the time sharing technique of GM amplifier. We apply test signal at phase 4 and observe the waveforms at both pins of GM amplifier. The waveforms show time sharing mechanism and the perfomance of GM to hold both input pins equal when the shared time is on.



Time (1µs/Div)

Figure 5

Over Current Protection

RT9245B uses an external resistor R_{IMAX} to set a programmable over current trip point. OCP comparator compares each inductor current with this reference current. RT9245B uses hiccup mode to eliminate fault detection of OCP or reduce output current when output is shorted to ground.

$$\frac{1}{2} \times \frac{V_{\text{IMAX}}}{R_{\text{IMAX}}} \Leftrightarrow \frac{1}{3} \times \frac{I_{\text{L}} \times DCR}{R_{\text{CSN}}}$$

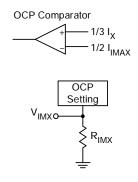


Figure 6. Over Current Comparator

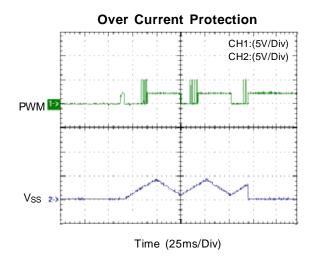
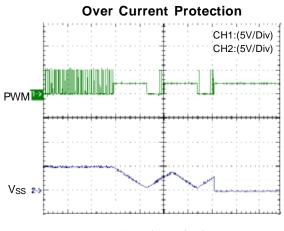


Figure 7. The Over Current Protection in the soft start interval



Time (25ms/Div)

Figure 8. Over Current Protection at steady state

Current Ratio Setting

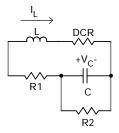


Figure 9. Application circuit for current ratio setting

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For some case with preferable current ratio instead of current balance, the corresponding technique is provided. Due to different physical environment of each channel, it is necessary to slightly adjust current loading between channels. Figure 9 shows the application circuit of GM for current ratio requirement. Applying KVL along L+DCR branch and R1+C//R2 branch :

$$\begin{split} &L\frac{dI_{L}}{dt} + DCR \times I_{L} = R_{1}(\frac{V_{C}}{R_{2}} + C\frac{dV_{C}}{dt}) + V_{C} \\ &= R_{1}C\frac{dV_{C}}{dt} + \frac{R_{1} + R_{2}}{R_{2}}V_{C} \\ &For \quad V_{C} = \frac{R2}{R_{1} + R_{2}}DCR \times I_{L} \end{split}$$

Look for its corresponding conditions :

$$L\frac{dI_{L}}{dt} + DCR \times I_{L} = (R1//R2) \times C \times DCR \times \frac{dI_{L}}{dt} + DCR \times I_{L}$$

Let
$$\frac{L}{DCR} = (R1//R2) \times C$$

Thus if
$$\frac{L}{DCR} = (R1//R2) \times C$$

Then $V_C = \frac{R2}{R1+R2} \times DCR \times I_L$

L

With internal current balance function, this phase would share $(R_1+R_2)/R_2$ times current than other phases. Figure 10 & 11 show different settings for the power stages. Figure 12 shows the performance of current ratio compared with conventional current balance function in Figure 13.

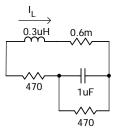


Figure 10. GM4 Setting for current ratio function

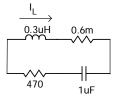
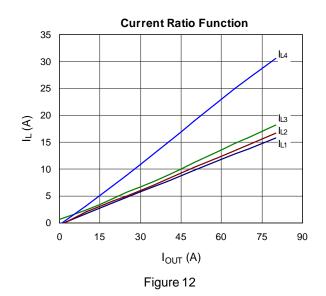
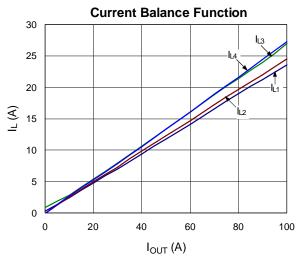


Figure 11. GM1~3 Setting for current ratio function









Dead Zone Elimination

RT9245B samples and holds inductor current at 50% period by time-sharing sourcing a current I_X to R_{CSN}. At light load condition when inductor current is not balance, voltage V_X across the sensing capacitor would be negative. It needs a negative I_X to sense the voltage. However, RT9245B CANNOT provide a negative I_X and consequently cannot sense negative inductor current. This results in dead zone of load line performance as shown in Figure 14. Therefore a technique as shown in Figure 15 is required to eliminate the dead zone of load line at light load condition.

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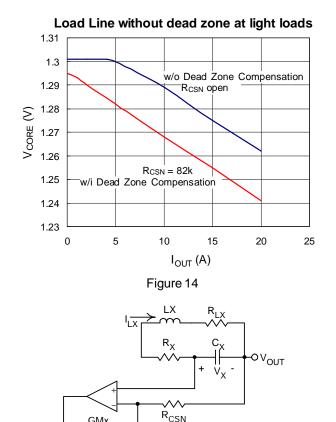


Figure 15. Application circuit of GM

≶r_{csn₂}

Referring to Figure 15, I_X is expressed as :

GMx

Iх

$$Ix = \frac{V_{OUT}}{R_{CSN2}} + \frac{I_{LX}_{50\%} x R_{LX}}{R_{CSN2}} + \frac{I_{LX}_{50\%} x R_{LX}}{R_{CSN}}$$
(1)

where ILX 50% is the of inductor current at 50% period. To make sure RT9245B could sense the inductor current, right hand side of Equation (1) should always be positive:

$$\frac{V_{OUT}}{R_{CSN2}} + \frac{I_{LX_{50\%}} x R_{LX}}{R_{CSN2}} + \frac{I_{LX_{50\%}} x R_{LX}}{R_{CSN}} \ge 0$$
(2)

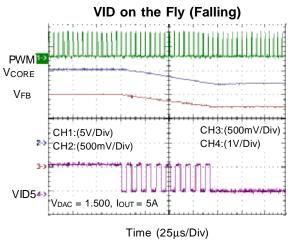
Since R_{CSN2} >> R_{CSN} in practical application, Equation (2) could be simplified as :

$$\frac{\text{VOUT}}{\text{RCSN2}} \ge \frac{|\text{LX}_{50\%} \text{ x RLx}|}{\text{RCSN}}$$

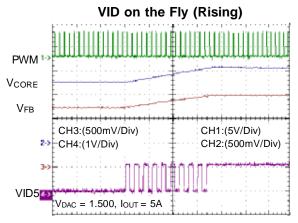
Figure 14 shows that dead zone of load line at light load is eliminated by applying this technique.

VID on the Fly

With external pull up resistors tied to VID pins, RT9245B converters different VID codes from CPU into output voltage. Figure 16 and Figure 17 show the waveforms of VID on the fly function.







Time (25µs/Div)



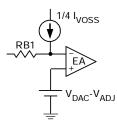


Figure 18. Offset Setting

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Output Voltage Offset Function

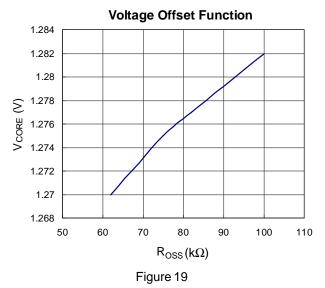
To meet AMD K8 requirement of initial offset of load line, RT9245B provides programmable initial offset function. External resistor R_{VOSS} and voltage source at VOSS pin generate offset current $I_{VOSS} = \frac{V_{VOSS}}{R_{VOSS}}$

, where V_{VOSS} is 1V typical. One quarter of I_{VOSS} flows through RB1 as shown in Figure 18. Error amplifier would hold the inverting pin equal to V_{DAC} - V_{ADJ} . Thus output voltage is subtracted from V_{DAC} - V_{ADJ} for a constant offset voltage.

$$V_{\text{CORE}} = V_{\text{DAC}} - V_{\text{ADJ}} - \frac{R_{\text{FB1}}}{4 \times R_{\text{VOSS}}}$$

A positive output voltage offset is possible by connecting $R_{\rm VOSS}$ to VDD instead of to GND. Please note that when $R_{\rm VOSS}$ is connected to VDD, $V_{\rm VOSS}$ is $V_{\rm DD}-2V$ typically and half of $I_{\rm VOSS}$ flows through $R_{\rm FB1}.$ $V_{\rm CORE}$ is rewritten as:

$$V_{CORE} = V_{DAC} - V_{ADJ} + \frac{R_{FB1}}{R_{VOSS}}$$



Load Line Setting and Thermal Compensation

 $V_{ADJ} = 8 \times AVG(I_X) \times R_{ADJ}$

 $V_{OUT} = V_{DAC} - V_{ADJ}$

 $AVG(I_X)$ is a PTC current. By properly use an NTC resistor at ADJ. Load line can be thermally compensated.

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PGOOD Function

During start-up, RT9245B will detect $5V_{CC}$ and $12V_{IN}$ (through DVD pin). In Figure 21, $5V_{CC}$ or $12V_{IN}$ is not ready during T1. $V_{(SS)}$ (in Figure 20) is pulled to GND by FAULT. $V_{(EAP)}$ is also equal to GND. $V_{(FB)}$ and V_{OUT} will try to follow $V_{(EAP)}$ thus both $V_{(FB)}$ and V_{OUT} are equal to GND during T1. During T2, both $5V_{CC}$ and $12V_{IN}$ are ready, FAULT = low, OPSS starts charging up C_{SS}. In the design of RT9245B, I_{SS} (the maximal current sink and source capability of OPSS) is limited and time-variant. During T2 (V1 = $0.4V > V_{(SS)} > 0$), I_{SS}(T2) is equal to about 10uA.

$$T2 = Css \ x \ \frac{V1}{Iss(T2)} \cong 4x10^4 \ x \ Css$$

After V_(SS) > V1, I_{SS} changes to about 20uA. The rising speed of V_(SS) becomes about 2 times faster than in T1. In Figure 20, MOSFET N1 will turn on only if V_(SS) > V_{TH_N1} (threshold voltage of N1) \cong 0.7V = V2. Before N1 turns on, V_(EAP) is still 0V.

$$T3 = Css \ x \frac{(V2 - V1)}{Iss(T3)} \cong 1.5x10^4 \ x \ Css$$

After V_(SS) > V2, MOSFET N1 turns on, V_(EAP) starts rising. I_{SS}(T4) is still equal to about 20uA. V_(SS,EAP) is equal to V_{TH_N1}. Due to the body effect of MOSFET N1, V_{TH_N1} increases with higher V_(EAP). For example, if V_{OUT} target is 1.4V, V_(SS,EAP) will be equal to about 0.7V at the beginning of T4 and equal to about 1.1V at the end of T4.

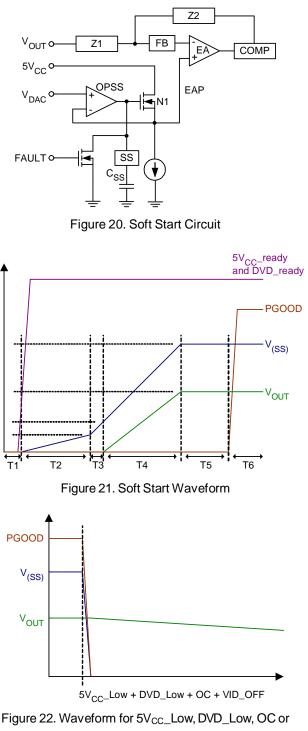
$$T4 = Css \ x \ \frac{(V4 - V2)}{Iss_{(T4)}} \cong 9x10^4 \ x \ Css$$

At the end of T4, V_{OUT} is very close to the target (within the range of ±40mV). An internal 1ms timer starts. After about 1ms(T5), The open-drain output PGOOD releases.

After PGOOD releases, $I_{SS}(T6)$ becomes about 320uA to accelerate OPSS. RT9245B enters normal operation mode and is capable to follow VID on the fly.

When any of the fault conditions happens, $V_{(SS)}$ and PGOOD will be pulled low immediately. If the fault condition is one of 5V_{CC} low, DVD low, OC or VID_OFF, RT9245B will try to turn off both high side MOSFET and low side MOSFET. V_{OUT} will fall slowly to avoid negative V_{OUT}. The typical waveform is shown in Figure 22.

If the fault condition is OV, $V_{(SS)}$ and PGOOD will be pulled low immediately also. RT9245B will try to turn on low side MOSFET and turn off high side MOSFET. V_{OUT} will fall quickly to protect CPU from high voltage. The typical waveform is shown in Figure 23.



V4

V3

V2 V1

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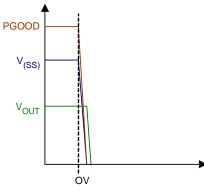


Figure 23. Waveform for OV

Error Amplifier Characteristic

For fast response of converter to meet stringent output current transient response, RT9245B provides large slew rate capability and high gain-bandwidth performance.

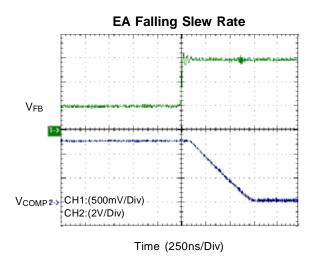
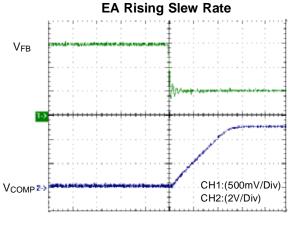


Figure 24. EA Rising Transient with 10pF Loading; Slew Rate = 8V/us



Time (250ns/Div)

Figure 25. EA Falling Transient with 10pF Loading; Slew Rate = 8V/us

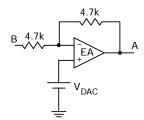


Figure 26. Gain-Bandwidth Measurement by signal A divided by signal B

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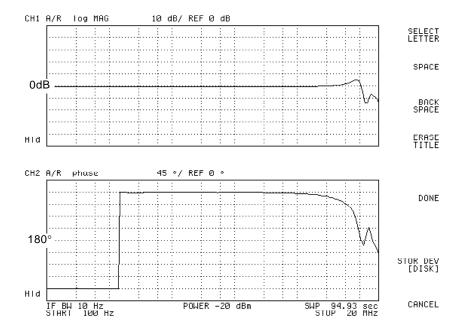


Figure 27. EA Frequency Response with closed loop gain set at 0db to observe gain-bandwidth product; -3dB at 10.86MHz

Design Procedure Suggestion	PCB Layout
a.Output filter pole and zero (Inductor, output capacitor	a.Kelvin sense for current sense GM amplifier input.
value & ESR).	b.Refer to layout guide for other items.
b.Error amplifier compensation & sawtooth wave amp- litude (compensation network).	Voltage Loop Setting
c.Kelvin sense for V_{CORE} .	Design Example
Current Loop Setting	Given:
a.GM amplifier S/H current (current sense component	Apply for four phase converter
DCR, CSN pin external resistor value).	V _{IN} = 12V
b. Over-current protection trip point (R_{IMAX} resistor).	$V_{CORE} = 1.4V$
VRM Load Line Setting	$I_{LOAD} = 30A$ to 125A
a.Droop amplitude (ADJ pin resistor).	V_{DROOP} = 95mV with load (1m Ω Load Line)
b.No load offset (R _{CSN2})	OCP trip point set at 40A for each channel (S/H)
c.DAC offset voltage setting (VOSS pin & compen- sation	DCR = $0.6m\Omega$ of inductor at 25°C
network resistor RB1).	$L = 0.3 \mu H$
Power Sequence & SS	$C_{OUT} = 5600 \mu F$ with $1 m \Omega$ equivalent ESR.

DVD pin external resistor and SS pin capacitor.

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1. Compensation Setting

a. Modulator Gain, Pole and Zero:

From the following formula:

Modulator Gain = V_{IN}/V_{RAMP} = 12/1.9 = 6.3 (i.e 16dB)

where V_{RAMP} : Ramp amplitude of saw-tooth wave

LC Filter Pole = 3.88kHz and

ESR Zero = 28kHz

b. EA Compensation Network:

Select RB1 = 1.5k, RB2 = 15k, C1 = 2.7nF, C2 = 5.6pF, C3 = 680pF and use the Type 3 compensation scheme shown in Figure 28. By calculation.

$$Fz_{1} = \frac{1}{2p \times RB1 \times C3} = 156 \text{kHz}$$

$$Fz_{2} = \frac{1}{2p \times RB2 \times C1} = 3.9 \text{kHz}$$

$$F_{P} = \frac{1}{2p \times RB2 \times (C2//C1)} = 5.8 \text{kHz}$$
Middle Band Gain = 10 (i.e. 20dB)

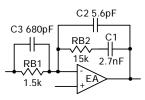


Figure 28. Type 3 compensation network of EA

The over all loop gain with load is shown in Figure 29 to Figure 31.

3. Over-Current Protection Setting

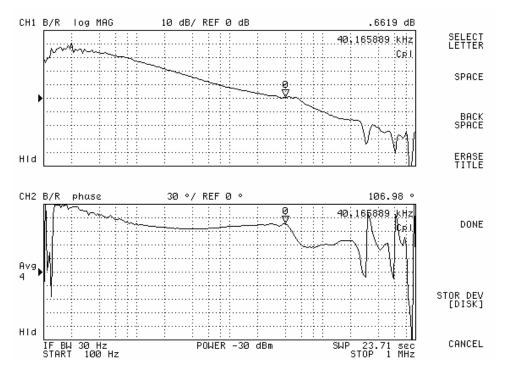
Consider the temperature coefficient of copper 3900ppm/°C,

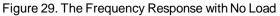
$1 V_{IMAX}$	⇔	$1 I_L \times DCR$
2 ^{RIMAX}	\leftarrow	3 [^] RCOMMON
1_1.690V	⇔	1 $40A \times 1.39m\Omega$
2 [^] R _{IMAX}	\hookrightarrow	3 [^] 330Ω

Let $R_{IMAX} = 14k\Omega$

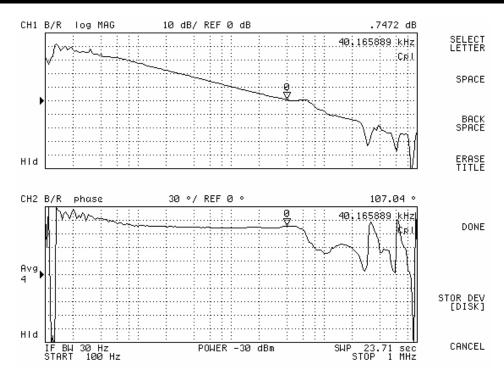
4. Soft-Start Capacitor Selection

For most application cases, $0.1 \mu F$ is a good engineering value.











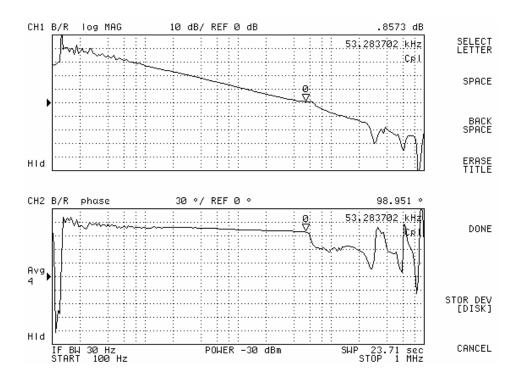


Figure 31. The Frequency Response with Heavy Load

Layout Guide

Place the high-power switching components first, and separate them from sensitive nodes.

- 1. Most critical path: the current sense circuit is the most sensitive part of the converter. The current sense resistors tied to CSP1,2,3,4 and CSN should be located not more than 0.5 inch from the IC and away from the noise switching nodes. The PCB trace of sense nodes should be parallel and as short as possible.
- 2. Switching ripple current path:
 - a. Input capacitor to high side MOSFET.
 - b. Low side MOSFET to output capacitor.
 - c. The return path of input and output capacitor.
 - d. Separate the power and signal GND.
 - e. The switching nodes (the connection node of high/low side MOSFET and inductor) is the most noisy points. Keep them away from sensitive small-signal node.
 - f. Reduce parasitic R, L by minimum length, enough copper thickness and avoiding of via.
- 3. MOSFET driver should be closed to MOSFET.
- 4. The compensation, bypass and other function setting components should be near the IC and away from the noisy power path.

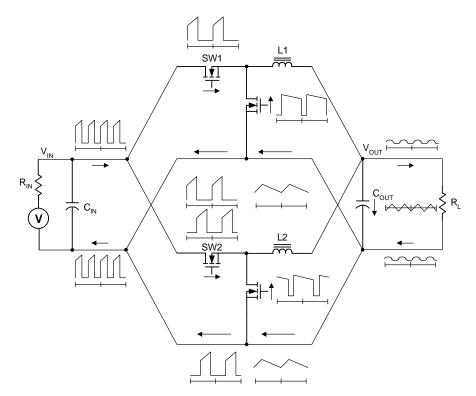


Figure 32. Power Stage Ripple Current Path



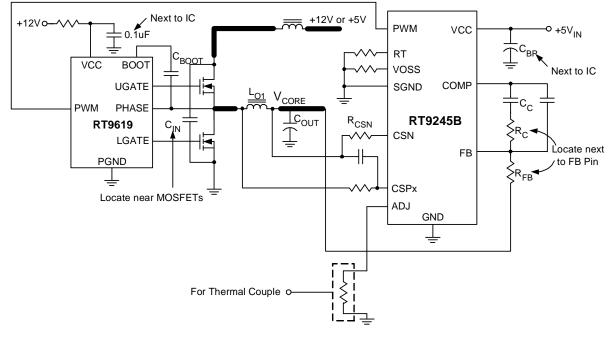
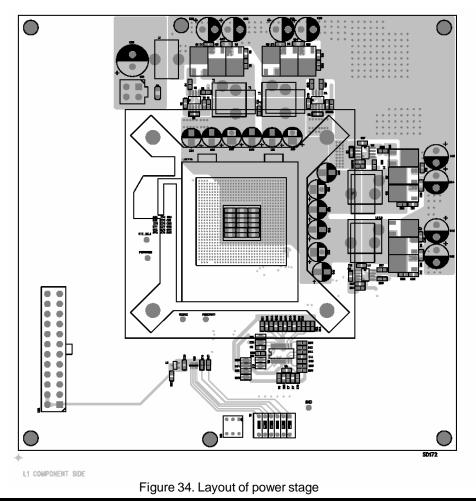
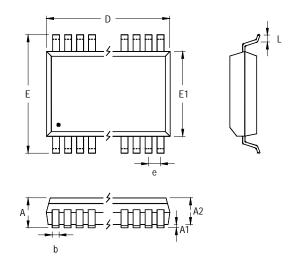


Figure 33. Layout Consideration



Outline Dimension



Symbol	Dimensions	n Millimeters	Dimensions In Inches		
Symbol	Min	Max	Min	Max	
А	0.850	1.200	0.033	0.047	
A1	0.050	0.152	0.002	0.006	
A2	0.800	1.050	0.031	0.041	
b	0.178	0.305	0.007	0.012	
D	9.601	9.804	0.378	0.386	
е	0.6	50	0.0	26	
E	6.300	6.500	0.248	0.256	
E1	4.293	4.496	0.169	0.177	
L	0.450	0.762	0.018	0.030	

28-Lead TSSOP Plastic Package

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